

Electronic Acknowledgement Receipt

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Application Number:	10566810
International Application Number:	
Confirmation Number:	8034
Title of Invention:	Complex laminated chip element
First Named Inventor/Applicant Name:	In-Kil Park
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Filer:	Hosoon Lee/Mccartney Secharmidal
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Attorney Docket Number:	3576-017
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Time Stamp:	20:44:08
Application Type:	U.S. National Stage under 35 USC 371

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File Listing:

Document Number	Document Description	File Name	File Size(Bytes)/Message Digest	Multi Part/.zip	Pages (if appl.)
1	Information Disclosure Statement (IDS) Filed (SB/08)	US_IDS_Form__SB_08a.pdf	612815 e81de2f5ca399094b6a2d6df51e1bd10c313 36b	no	5

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2		IDS-cited-2-25-10-a.pdf	17926917 M1020e64f15c8d256c97fb3a3f26536af1 f530	yes	113
Multipart Description/PDF files in .zip description					
Document Description		Start	End		
Transmittal Letter		1	1		
Foreign Reference		2	3		
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Foreign Reference		20	25		
Foreign Reference		26	37		
Foreign Reference		38	46		
Foreign Reference		47	56		
Foreign Reference		57	67		
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Foreign Reference		79	99		
Foreign Reference		100	106		
Foreign Reference		107	113		

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3		IDS-cited-2-25-10-b.pdf	4464936 96c88c6c8e6f6a7afe90fb1a364762caf d4fb45	yes	53
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Multipart Description/PDF files in .zip description			
Document Description		Start	End
	Foreign Reference	1	31
	Foreign Reference	32	53

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National Stage of an International Application under 35 U.S.C. 371

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